

CALL FOR PAPERS

ISLPED 2015

INTERNATIONAL SYMPOSIUM ON LOW POWER ELECTRONICS AND DESIGN



<http://www.islped.org>

Rome, Italy

July 22 – July 24, 2015



Information: islped@islped.org
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Sponsored by the **IEEE Circuits and Systems Society (CASS)** and the **ACM Special Interest Group on Design Automation (SIGDA)**.

The International Symposium on Low Power Electronics and Design (ISLPED) is the premier forum for presentation of innovative research in all aspects of low power electronics and design, ranging from process technologies and analog/digital circuits, simulation and synthesis tools, system-level design and optimization, to system software and applications. Specific topics include, but are not limited to, the following three main tracks and sub-areas:

1. Technology, Circuits, and Architecture	2. CAD, Systems, and Software
1.1. Technologies Low-power technologies for Device, Interconnect, Logic, Memory, 2.5/3D, Cooling, Harvesting, Sensors, Optical, Printable, Biomedical, Battery, and Alternative energy storage devices.	2.1. CAD Tools and Methodologies CAD tools and methodologies for low-power and thermal-aware design addressing power estimation, optimization, reliability and variation impact on power, and power-down approaches at all levels of design abstraction: physical, circuit, gate, register transfer, behavior, and algorithm.
1.2. Circuits Low-power digital circuits for Logic, Memory, Reliability, Clocking, Power gating, Resiliency, Near-threshold and Sub-threshold, Variability, and Digital assist schemes; Low-power analog/mixed-signal circuits for Wireless, RF, MEMS, AD/DA Converters, I/O, PLLs/DLLs, Imaging, DC-DC converters, and Analog assist schemes.	2.2. Systems and Platforms Low-power, power-aware, and thermal-aware system design and platforms for microprocessors, DSPs, embedded systems, FPGAs, ASICs, SoCs, heterogeneous computing, data-center power delivery and cooling, and system-level power implications due to reliability and variability.
1.3. Logic and Architecture Low-power logic and microarchitecture for SoC designs, Processor cores (compute, graphics and other special purpose cores), Cache, Memory, Arithmetic/Signal processing, Cryptography, Variability, Asynchronous design, and Non-conventional computing.	2.3. Software and Applications Energy-efficient, energy-aware, and thermal-aware system software and application design including scheduling and management, power optimizations through HW/SW interactions, and emerging low power applications such as approximate and brain-inspired computing, the Internet-of-Things (IoT), wearable computing, body-area/in-body networks, and wireless sensor networks.
3. Industrial Design Track (New Initiative for 2015)	
3.1. Industry Perspectives For the first time, ISLPED'15 solicits papers for an "Industrial Design" track to reinforce interaction between the academic research community and industry. Industrial Design track papers have the same submission deadline as regular papers and should focus on similar topics, but are expected to provide a complementary perspective to academic research by focusing on challenges, solutions, and lessons learnt while implementing industrial-scale designs. In addition to purely hardware-focused papers, papers describing power optimizations through an interaction of hardware and software are also welcome.	

Submissions on new topics: emerging technologies, architectures/platforms, and applications are particularly encouraged.

Technical Paper Submission Deadlines: Abstract reg. ~~Feb 22~~ **March 1, 2015, at 11:59pm Pacific Standard Time;**
Full paper ~~March 1~~ **March 8, 2015, at 11:59pm Pacific Daylight Time**

Invited Talk, Panel, and Embedded Tutorial Proposals Deadline: **April 1, 2015**

Notification of Paper Acceptance: May 1, 2015

Submission of Camera-Ready Papers: June 1, 2015

Submissions should be full-length papers of **up to 6 pages** (PDF format, double-column, US letter size, using the IEEE Conference format, available at http://www.ieee.org/conferences_events/conferences/publishing/templates.html), including all illustrations, tables, references, and an abstract of no more than 250 words. **Submissions must be anonymous.** Submissions exceeding 6 pages or identifying the authors, either directly or through explicit references to their prior work, will be automatically rejected. More information about paper submission can be found at <http://www.islped.org>.

Submitted papers must describe original work that has not been published/accepted or currently under review by another journal, conference, symposium, or workshop at the same time. Accepted papers will be submitted to the IEEE Xplore Digital Library and the ACM Digital Library. ISLPED'15 will present two Best Paper Awards based on the ratings of reviewers and a panel of judges.

There will be several invited talks by industry and academic thought leaders on key issues in low power electronics and design. The Symposium may also include embedded tutorials to provide attendees with the necessary background to follow recent research results, as well as panel discussions on future directions in low power electronics and design. Proposals for invited talks, embedded tutorials, and panels should be sent by email to the ISLPED'15 Technical Program Co-Chairs, Vijay Raghunathan (vr@purdue.edu) and Ruchir Puri (ruchir@us.ibm.com) by the deadline listed above.

Participants interested in exhibiting at the Symposium should contact the General Co-Chairs by May 1, 2015.